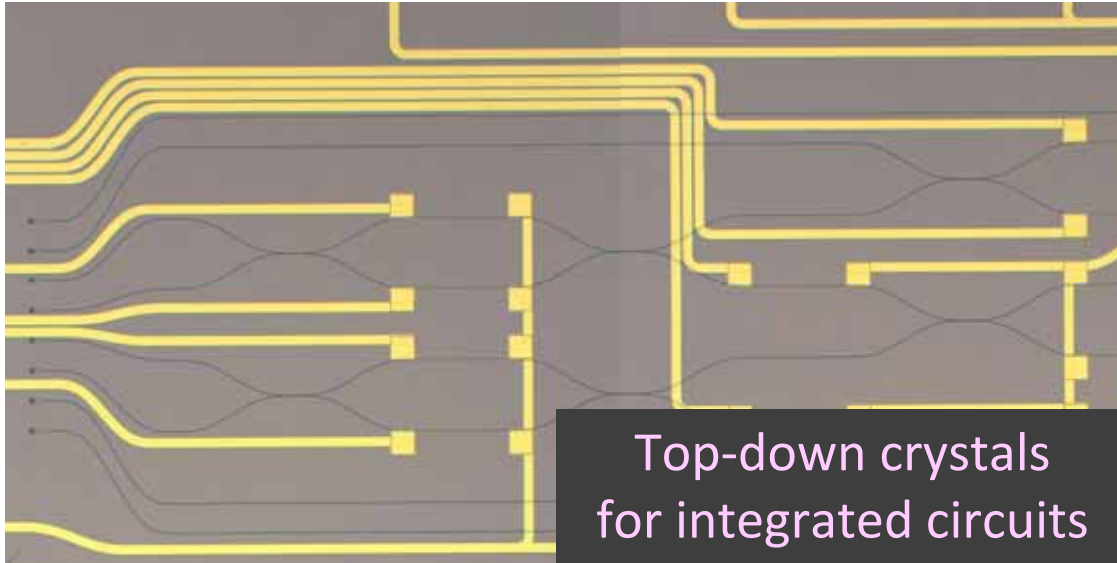
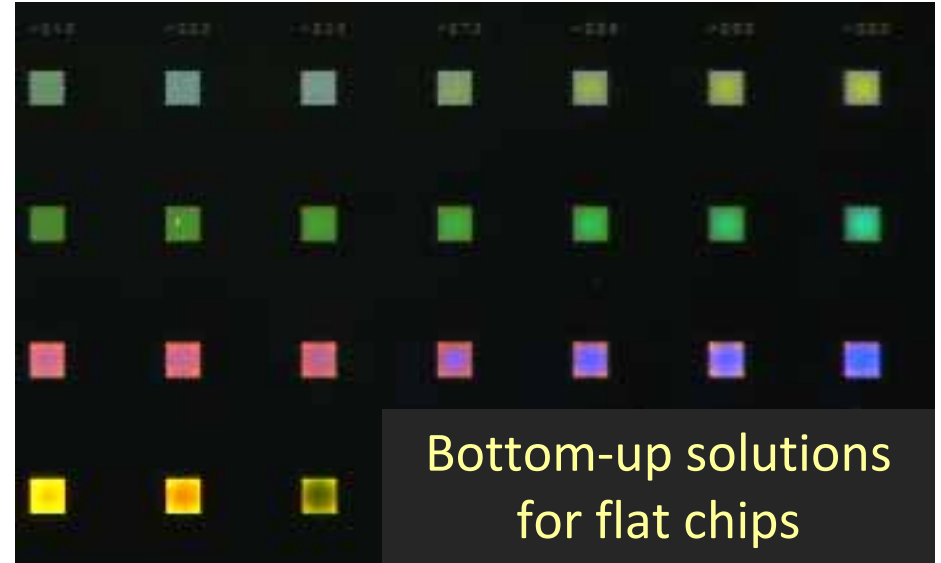


Thin Film Lithium Niobate for Modulators and Beyond



Top-down crystals
for integrated circuits



Bottom-up solutions
for flat chips

Rachel Grange

Department of Physics

Institute for Quantum Electronics

Optical Nanomaterial Group

www.ong.ethz.ch

grange@phys.ethz.ch

The Optical Nanomaterial Group **ONG**



**Robert
Chapman**



**Giovanni
Finco**



**Sara
Gasser**



**Andreas
Maeder**



**Alfonso
Martinez**



**Andrea
Morandi**



**Jost
Kellner**



**Marc Reig
Escalé**



**Alessandra
Sabatti**



**Oliver
Pitz**



**Myriam
Rihani**



**Ülle-Linda
Talts**



**Luis
Mickeler**



**Pierre
Didier**



**Eleni
Prountzou**



**Tristan
Kuttner**



**Prakhar
Jain**



**Virginia
Falcone**



**Elise
Bailly**



**Odiel
Hooybergs**



**Tummas
Arge**



**Michelle
Schweitzer**



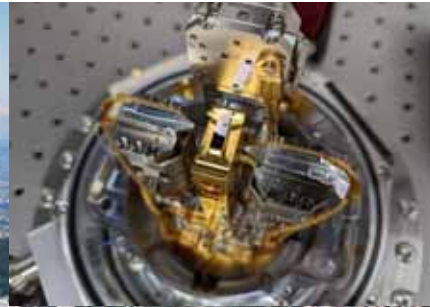
**Alessandro
Palermo**

Funding



Startups





Our goal

to engineer nonlinear and electro-optic signal at small scale for developing compact, efficient and robust classical or quantum devices
Design, nanofabrication & measurements of quadratic $\chi^{(2)}$ materials

Why miniaturizing quadratic optical materials?

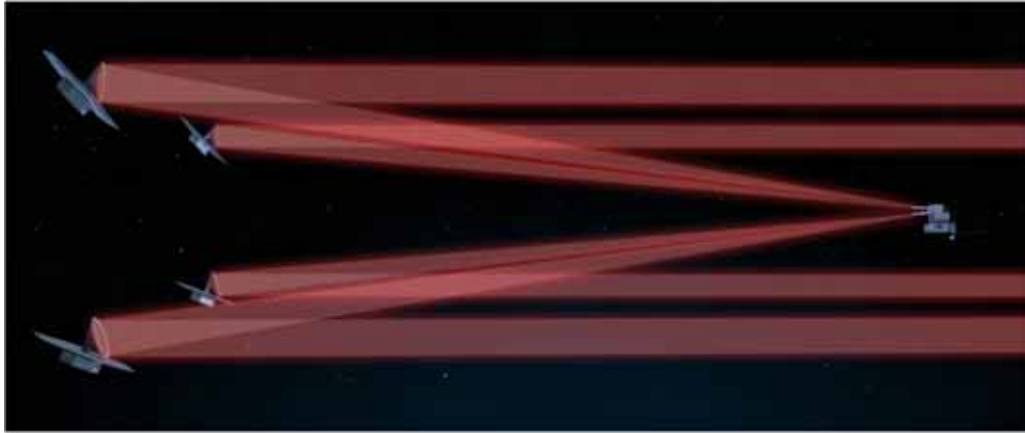


©ESA/ATG medialab

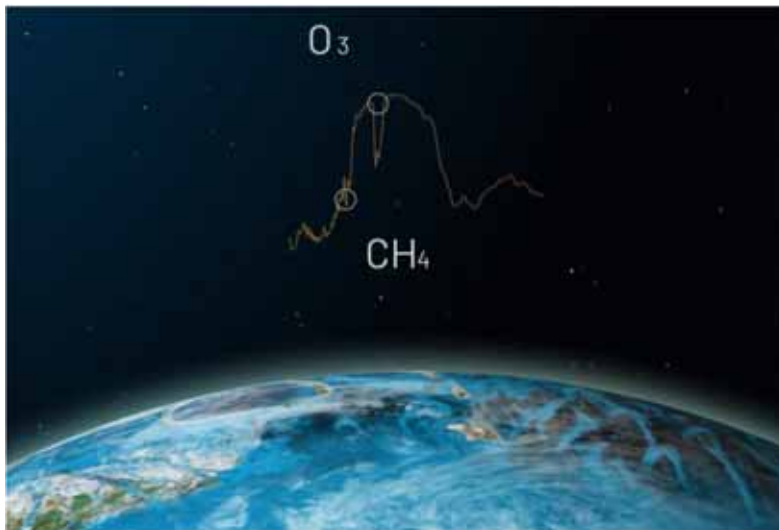
For data transport

- Small footprint
- High yield
- Low power
- Fast speed
- Low losses
- Light weight
- Robust

Why miniaturizing quadratic optical materials?



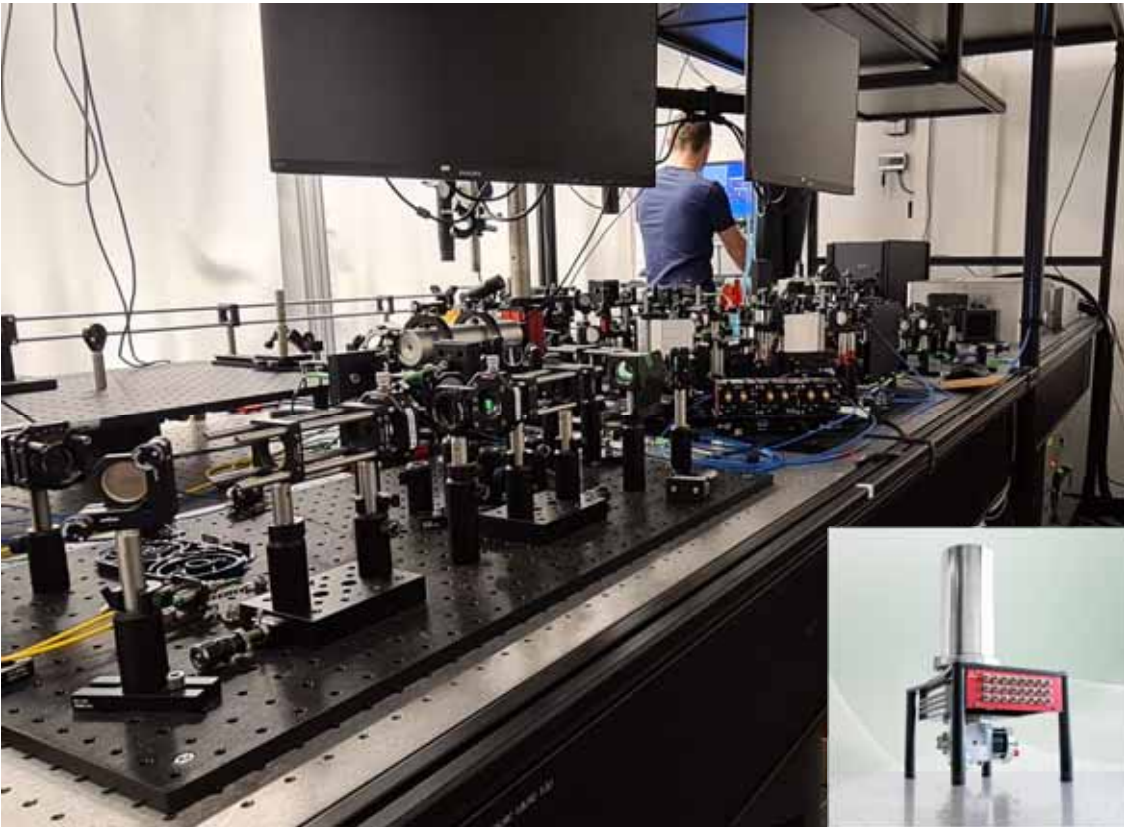
LIFE mission: Large Interferometer For Exoplanets



For data transport
For sensing

- Small footprint
- High yield
- Low power
- Fast speed
- Low losses
- Light weight
- Robust
- Broadband

Why miniaturizing quadratic optical materials?



Bulk and free space optics

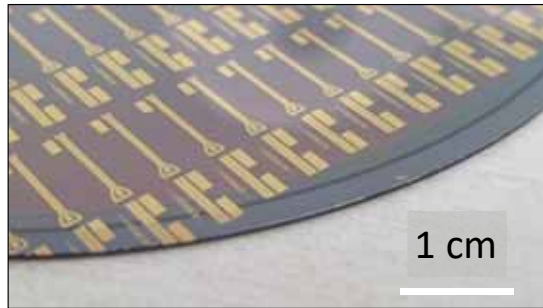


**For data transport
For sensing
For computing**

- Small footprint
- High yield
- Low power
- Fast speed
- Low losses
- Light weight
- Robust
- Broadband

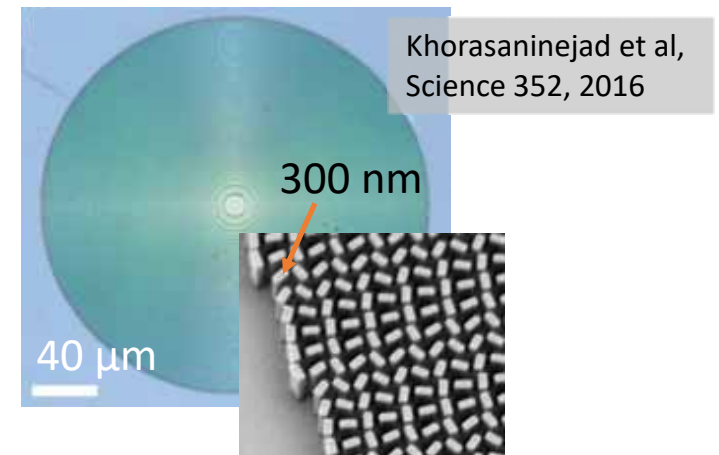
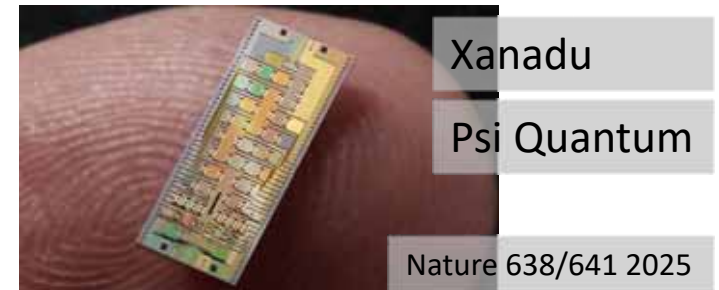
State of the art

Material platform?



generate, route, process,
modulate and detect light
on a chip

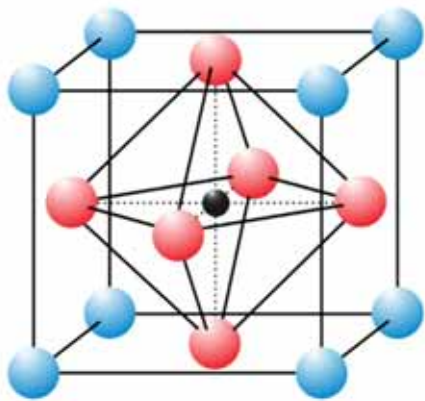
Current material



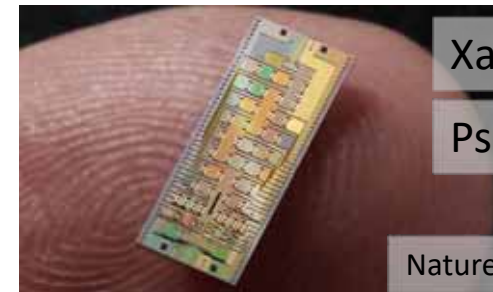
Silicon (Si), silicon nitride (SiN) or TiO_2

State of the art

Centrosymmetric



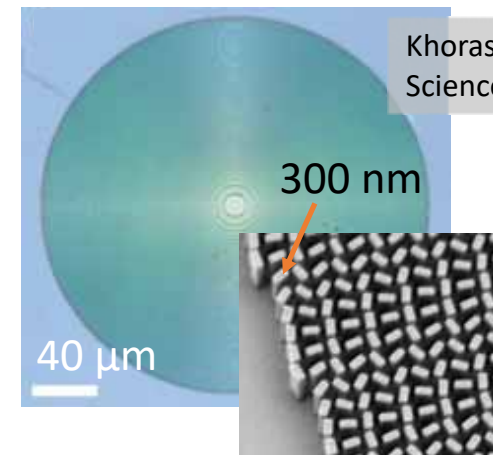
Current material



Xanadu

Psi Quantum

Nature 638/641 2025

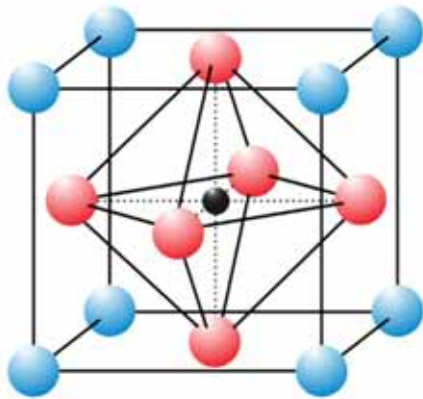


Khorasaninejad et al,
Science 352, 2016

Silicon (Si), silicon nitride (SiN) or TiO_2

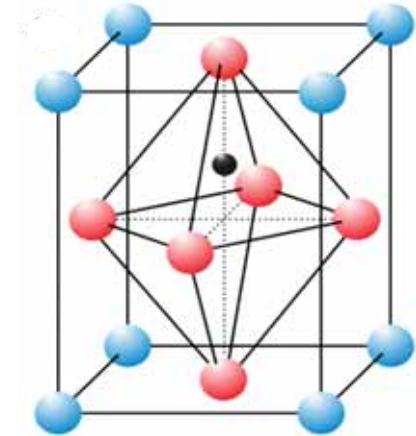
State of the art

Centrosymmetric



Silicon (Si), silicon nitride (SiN) or TiO_2

Non-Centrosymmetric

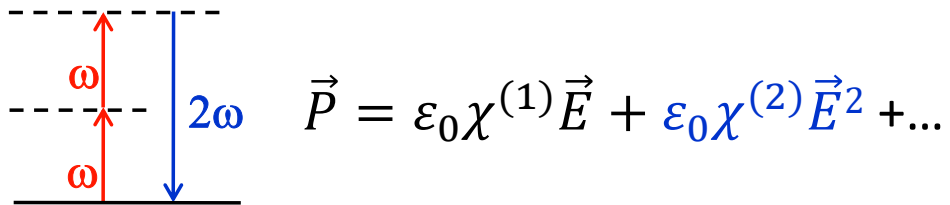


SiO_2 (crystalline quartz)
Gallium arsenide (GaAs)
Barium titanate (BaTiO_3)
Lithium niobate (LiNbO_3)

Nonlinear and quantum optics

Missing properties of Si, SiN, TiO₂

Frequency conversion

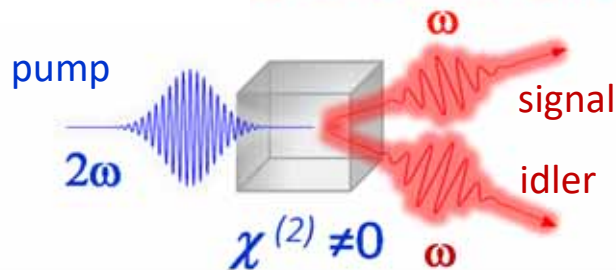


Electro-optic control



$$\Delta n \sim E$$

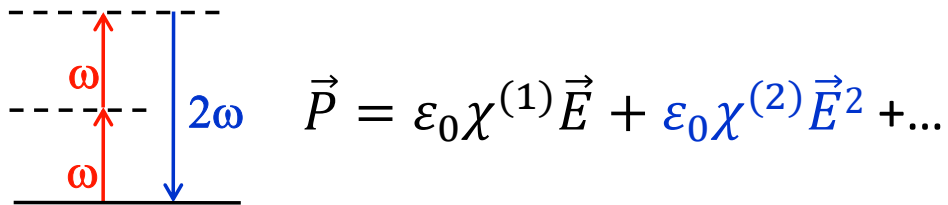
Entangled photon generation (SPDC)



Nonlinear and quantum optics

Missing properties of Si, SiN, TiO₂

Frequency conversion

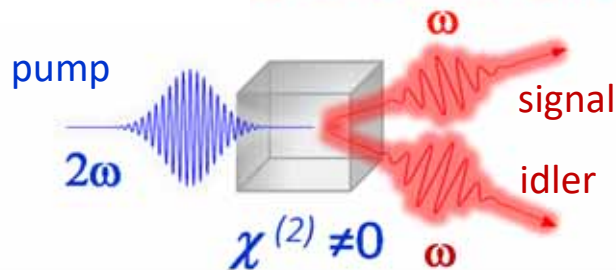


Electro-optic control

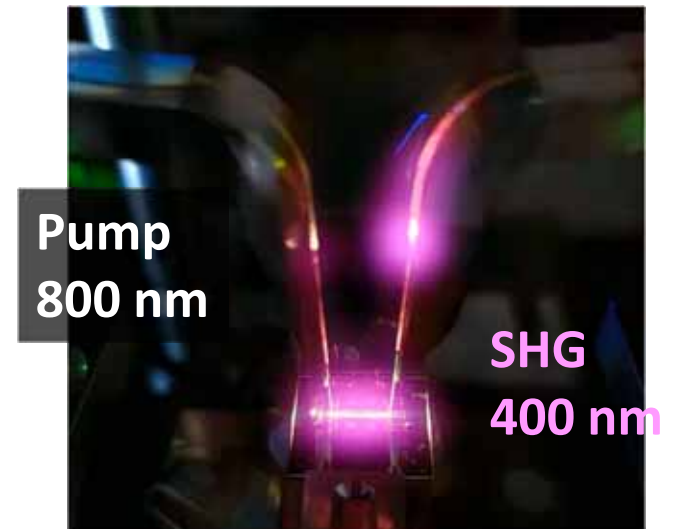


$$\Delta n \sim E$$

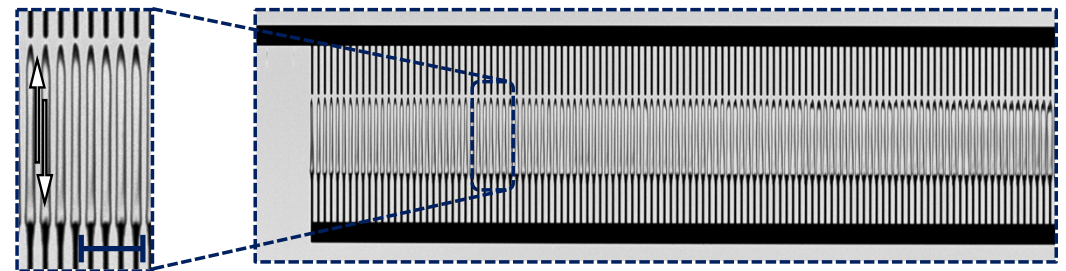
Entangled photon generation (SPDC)



Second-Harmonic Generation (SHG)



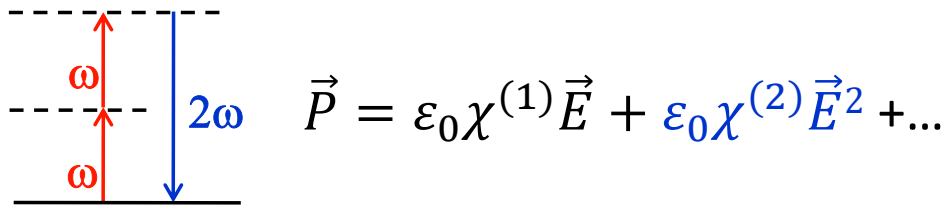
Up to 6 mm long PPLN waveguide



Nonlinear and quantum optics

Missing properties of Si, SiN, TiO₂

Frequency conversion

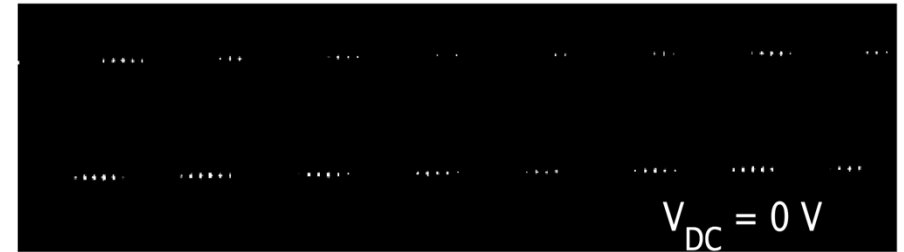


Electro-optic control

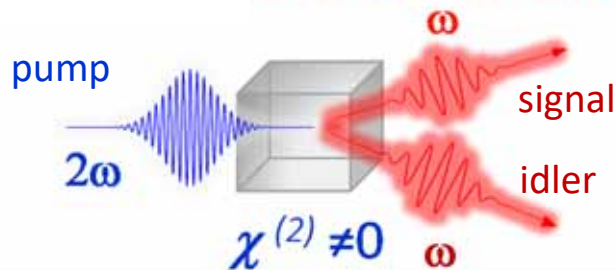


$$\Delta n \sim E$$

Pockels effect



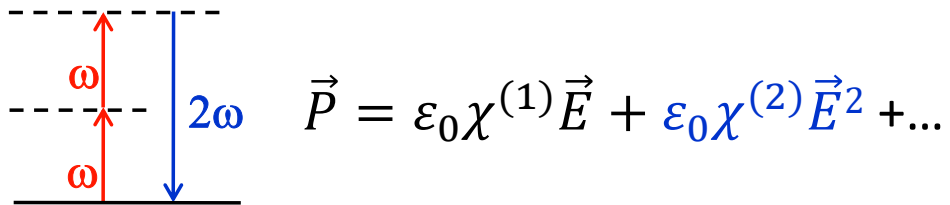
Entangled photon generation (SPDC)



Nonlinear and quantum optics

Missing properties of Si, SiN, TiO₂

Frequency conversion

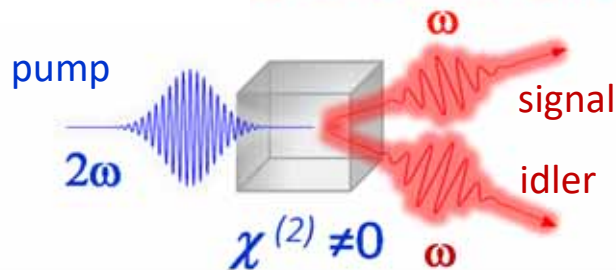


Electro-optic control



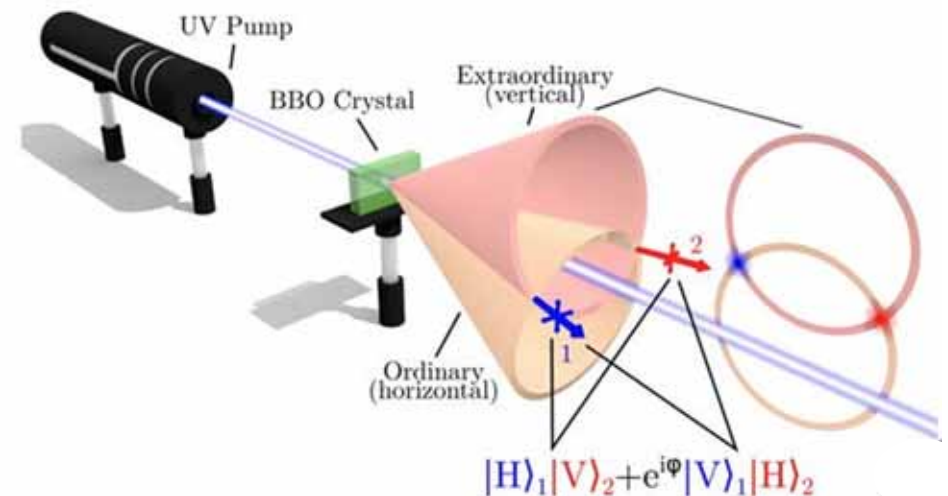
$$\Delta n \sim E$$

Entangled photon generation



Spontaneous Parametric Down Conversion (SPDC)

Source for quantum cryptography, teleportation, ...



Why BaTiO₃ and LiNbO₃ in particular?

λ Frequency conversion $\lambda/2$

$$\vec{P} = \epsilon_0 \chi^{(1)} \vec{E} + \epsilon_0 \chi^{(2)} \vec{E}^2 + \dots$$

Lithium niobate (LiNbO₃)

$$d_{il} = \begin{bmatrix} 0 & 0 & 0 & 0 & d_{31} & -d_{22} \\ -d_{22} & d_{22} & 0 & d_{31} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{bmatrix}$$

Material	d_{ij} (pm/V)
Silicon	0
SiO ₂	0.335
BaTiO ₃	6.8 to 17
LiNbO ₃	6 to 34
GaAs	134 to 256

Barium titanate (BaTiO₃)

$$d_{ij} = \begin{pmatrix} 0 & 0 & 0 & 0 & d_{15} & 0 \\ 0 & 0 & 0 & d_{15} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{pmatrix}$$

Why BaTiO₃ and LiNbO₃ in particular?

λ Frequency conversion $\lambda/2$

$$\vec{P} = \epsilon_0 \chi^{(1)} \vec{E} + \epsilon_0 \chi^{(2)} \vec{E}^2 + \dots$$

Electro-optic effect



Lithium niobate (LiNbO₃)

$$r_{lk} = \begin{bmatrix} 0 & -r_{22} & r_{13} \\ 0 & r_{22} & r_{13} \\ 0 & 0 & r_{33} \\ 0 & r_{42} & 0 \\ r_{42} & 0 & 0 \\ -r_{22} & 0 & 0 \end{bmatrix}$$

Barium titanate (BaTiO₃)

$$r_{ij} = \begin{pmatrix} 0 & 0 & r_{13} \\ 0 & 0 & r_{23} \\ 0 & 0 & r_{33} \\ 0 & r_{42} & 0 \\ r_{51} & 0 & 0 \\ 0 & 0 & 0 \end{pmatrix}$$

Material	d_{ij} (pm/V)	r_{ij} (pm/V)
Silicon	0	0
SiO ₂	0.335	0.2
BaTiO ₃	6.8 to 17	10-1300
LiNbO ₃	6 to 34	6-30
GaAs	134 to 256	1-2

del Rocio Camacho-Morales et al., Adv. Phot, 3, 2021

Santiago-Cruz, et al. Science, 377, 2022

Lithium niobate (LiNbO₃)

$$d_{il} = \begin{bmatrix} 0 & 0 & 0 & 0 & d_{31} & -d_{22} \\ -d_{22} & d_{22} & 0 & d_{31} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{bmatrix}$$

Barium titanate (BaTiO₃)

$$d_{ij} = \begin{pmatrix} 0 & 0 & 0 & 0 & d_{15} & 0 \\ 0 & 0 & 0 & d_{15} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{pmatrix}$$

Why BaTiO₃ and LiNbO₃ in particular?

λ Frequency conversion $\lambda/2$

$$\vec{P} = \epsilon_0 \chi^{(1)} \vec{E} + \epsilon_0 \chi^{(2)} \vec{E}^2 + \dots$$

Lithium niobate (LiNbO₃)

$$d_{il} = \begin{bmatrix} 0 & 0 & 0 & 0 & d_{31} & -d_{22} \\ -d_{22} & d_{22} & 0 & d_{31} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{bmatrix}$$

Material	d_{ij} (pm/V)	r_{ij} (pm/V)
Silicon	0	0
SiO ₂	0.335	0.2
BaTiO ₃	6.8 to 17	10-1300
LiNbO ₃	6 to 34	6-30
GaAs	134 to 256	1-2

Barium titanate (BaTiO₃)

$$d_{ij} = \begin{pmatrix} 0 & 0 & 0 & 0 & d_{15} & 0 \\ 0 & 0 & 0 & d_{15} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{pmatrix}$$

Frequency conversion (d_{ij}) vs
Electro-optic (r_{ij}) coefficients

LiNbO₃ $d_{ij} \approx r_{ij}$
BaTiO₃ $d_{ij} < r_{ij}$
GaAs $d_{ij} > r_{ij}$

Electro-optic effect



Lithium niobate (LiNbO₃)

$$r_{lk} = \begin{bmatrix} 0 & -r_{22} & r_{13} \\ 0 & r_{22} & r_{13} \\ 0 & 0 & r_{33} \\ 0 & r_{42} & 0 \\ r_{42} & 0 & 0 \\ -r_{22} & 0 & 0 \end{bmatrix}$$

Barium titanate (BaTiO₃)

$$r_{ij} = \begin{pmatrix} 0 & 0 & r_{13} \\ 0 & 0 & r_{23} \\ 0 & 0 & r_{33} \\ 0 & r_{42} & 0 \\ r_{51} & 0 & 0 \\ 0 & 0 & 0 \end{pmatrix}$$

Why BaTiO₃ and LiNbO₃ in particular?

λ Frequency conversion $\lambda/2$

$$\vec{P} = \epsilon_0 \chi^{(1)} \vec{E} + \epsilon_0 \chi^{(2)} \vec{E}^2 + \dots$$

Electro-optic effect



Lithium niobate (LiNbO₃)

$$r_{lk} = \begin{bmatrix} 0 & -r_{22} & r_{13} \\ 0 & r_{22} & r_{13} \\ 0 & 0 & r_{33} \\ 0 & r_{42} & 0 \\ r_{42} & 0 & 0 \\ -r_{22} & 0 & 0 \end{bmatrix}$$

Barium titanate (BaTiO₃)

$$r_{ij} = \begin{pmatrix} 0 & 0 & r_{13} \\ 0 & 0 & r_{23} \\ 0 & 0 & r_{33} \\ 0 & r_{42} & 0 \\ r_{51} & 0 & 0 \\ 0 & 0 & 0 \end{pmatrix}$$

Lithium niobate (LiNbO₃)

$$d_{il} = \begin{bmatrix} 0 & 0 & 0 & 0 & d_{31} & -d_{22} \\ -d_{22} & d_{22} & 0 & d_{31} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{bmatrix}$$

- ✓ Large band gap: 3-4 eV
Transparency: UV to MIR
- ✓ Refractive index > 2
Light confinement
- ✓ Very inert
solid but **hard to process**

Frequency conversion (d_{ij}) vs
Electro-optic (r_{ij}) coefficients

$$\text{LiNbO}_3 \quad d_{ij} \approx r_{ij}$$

$$\text{BaTiO}_3 \quad d_{ij} < r_{ij}$$

$$\text{GaAs} \quad d_{ij} > r_{ij}$$

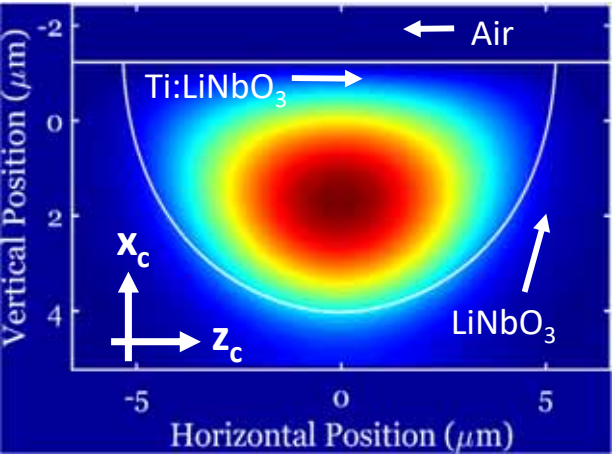
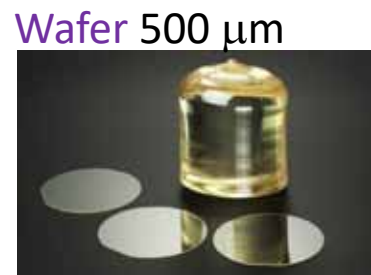
Barium titanate (BaTiO₃)

$$d_{ij} = \begin{pmatrix} 0 & 0 & 0 & 0 & d_{15} & 0 \\ 0 & 0 & 0 & d_{15} & 0 & 0 \\ d_{31} & d_{31} & d_{33} & 0 & 0 & 0 \end{pmatrix}$$

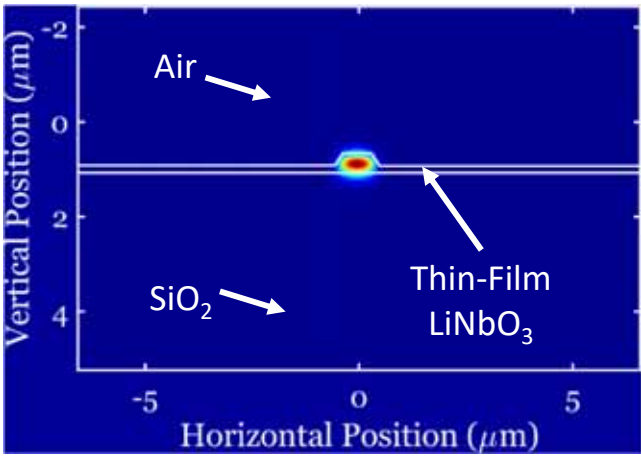
How small quadratic $\chi^{(2)}$ materials can be?

Top-down fabrication

Bulk crystals



Mode Area > 30 μm^2
40 Gbit/s



Mode Area < 1 μm^2
100 Gbit/s



Thin film < 1 μm

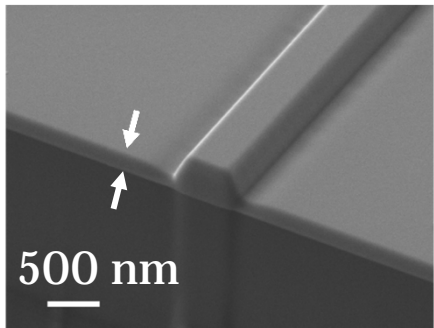
LiNbO₃ (<800 nm)

SiO₂ (2-5 μm)

Si (0.4-1 mm)

Sapphire

LiNbO₃



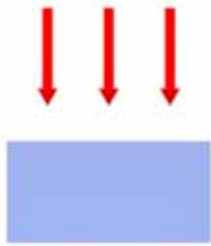
Rabiei, P.; Gunter, P. *Applied Physics Letters* **2004**, 85 (20).

Demanding top-down fabrication process

Challenge 1 : Thin film substrate

Ion slicing

(i) Ion Implantation



(ii) Wafer Bonding

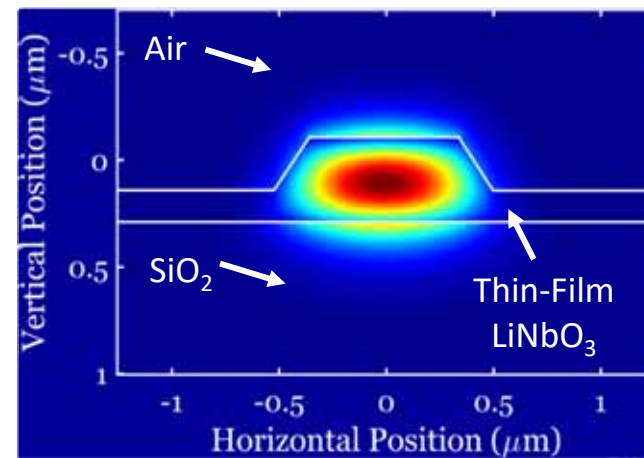


(iii) Heating



LNOI PIC Platform, H2020

<https://www.project-elena.eu/>



Mode Area $< 1 \mu\text{m}^2$

Thin film $< 1 \mu\text{m}$

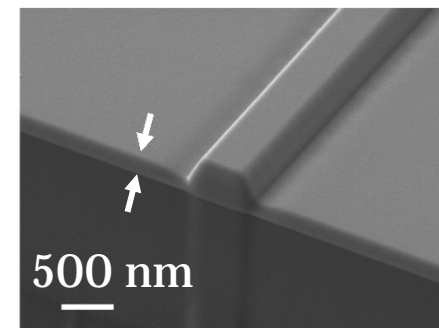
LiNbO₃ ($< 800 \text{ nm}$)

SiO₂ ($2\text{-}5 \mu\text{m}$)

Si ($0.4\text{-}1 \text{ mm}$)

Sapphire

LiNbO₃



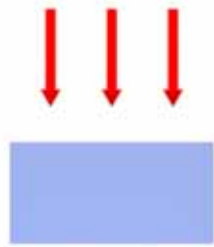
Rabiei, P.; Gunter, P. *Applied Physics Letters* **2004**, *85* (20).

Demanding top-down fabrication process

Challenge 1 : Thin film substrate

Ion slicing

(i) Ion Implantation



(ii) Wafer Bonding



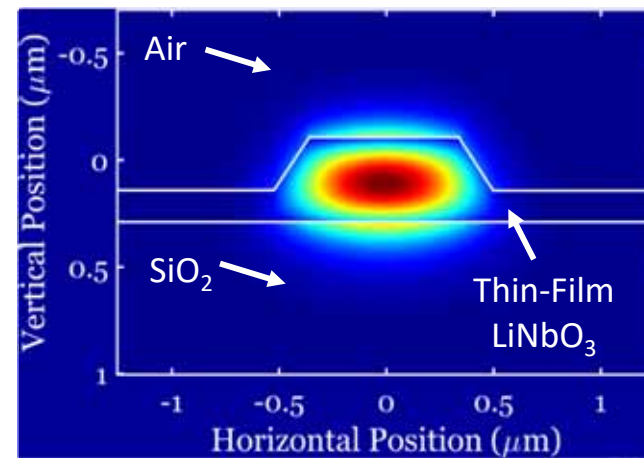
(iii) Heating



LNOI PIC Platform, H2020

<https://www.project-elena.eu/>

Smart cut fab at CEA-LETI, France



Mode Area < 1 μm^2

Thin film < 1 μm

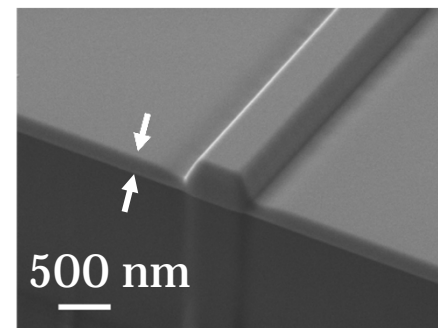
LiNbO₃ (<800 nm)

SiO₂ (2-5 μm)

Si (0.4-1 mm)

Sapphire

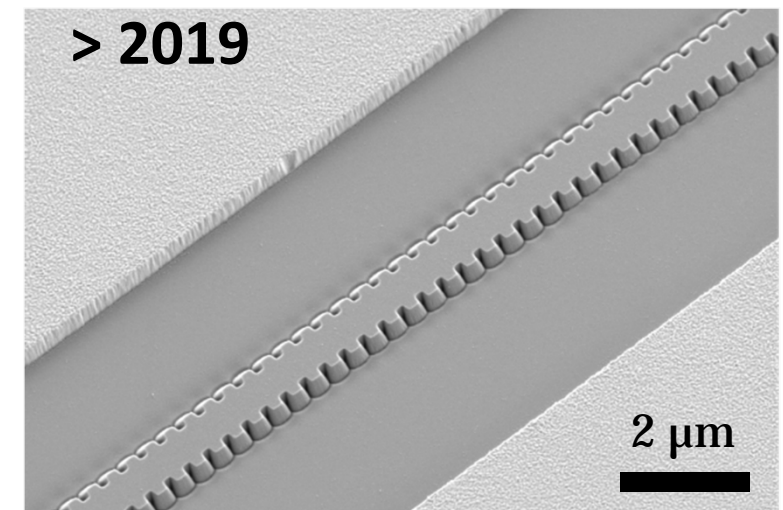
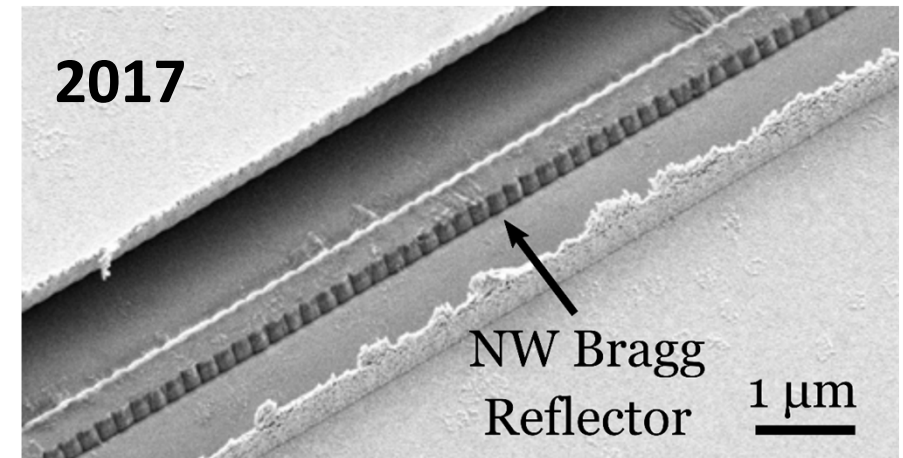
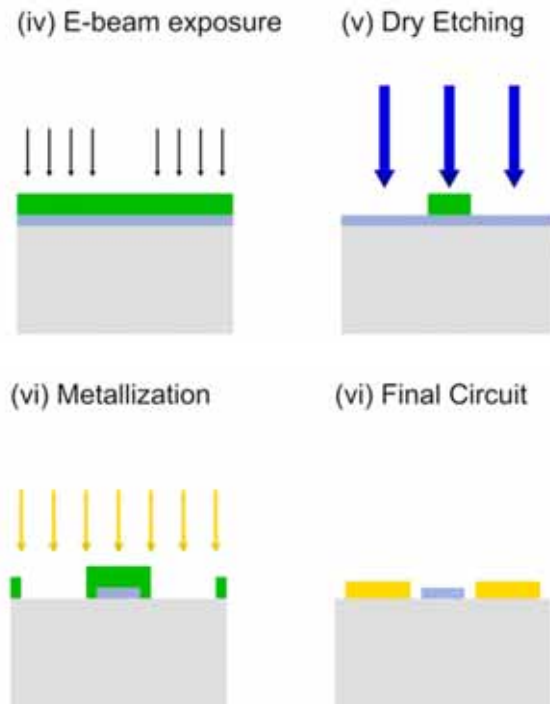
LiNbO₃



Demanding top-down fabrication process

Challenge 1 : Thin film substrate

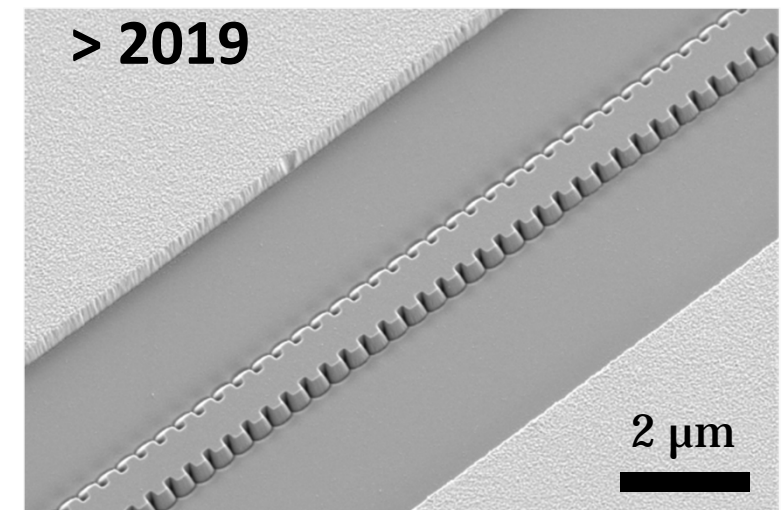
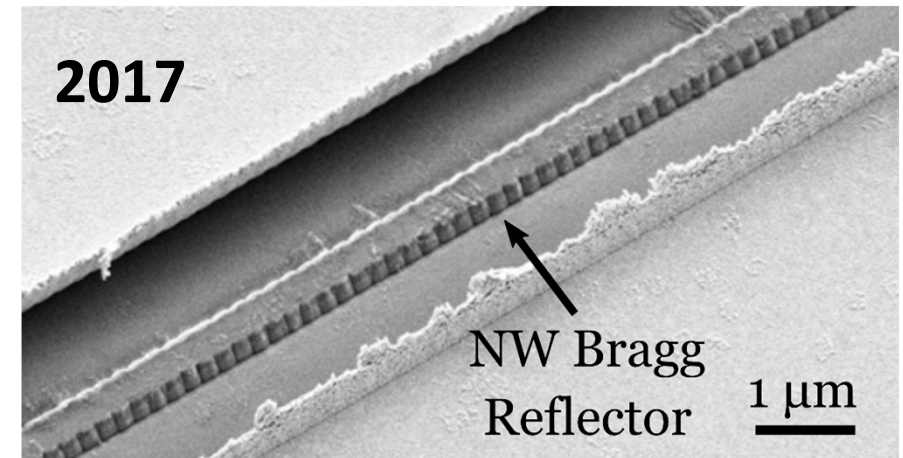
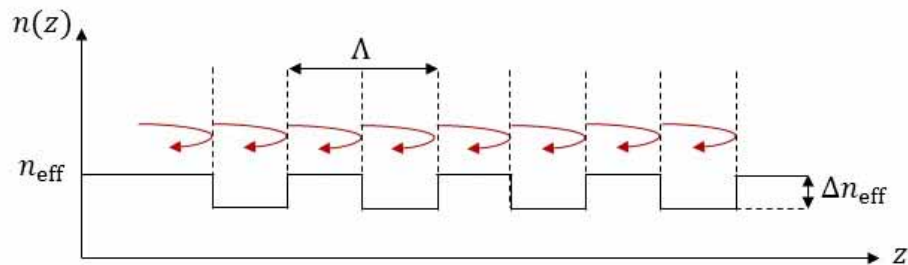
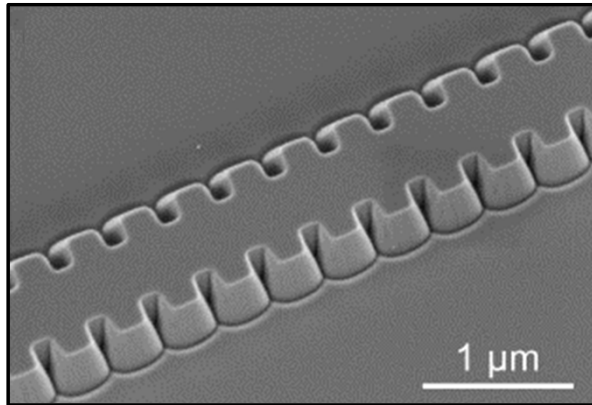
Challenge 2 : Film patterning



Demanding top-down fabrication process

Distributed Bragg reflector

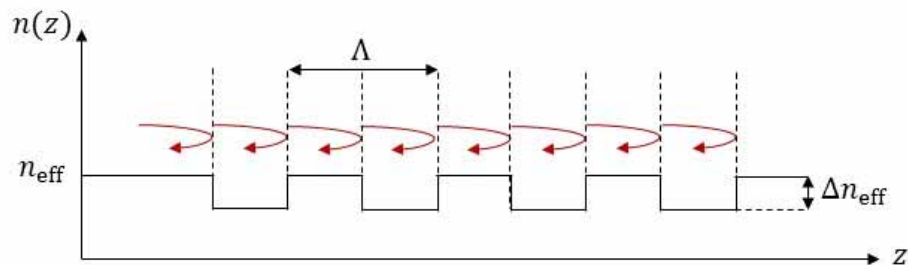
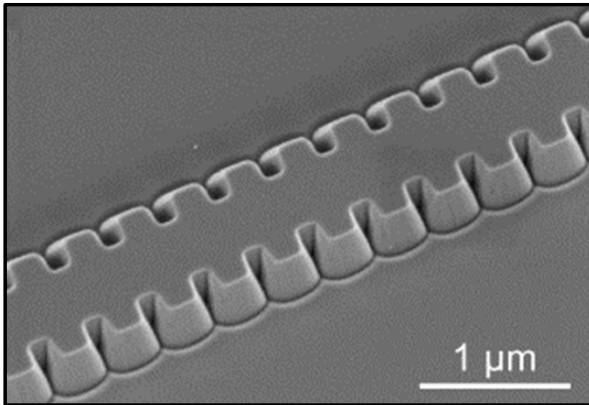
Multilayers of alternating materials with varying n , each layer causes a partial reflection



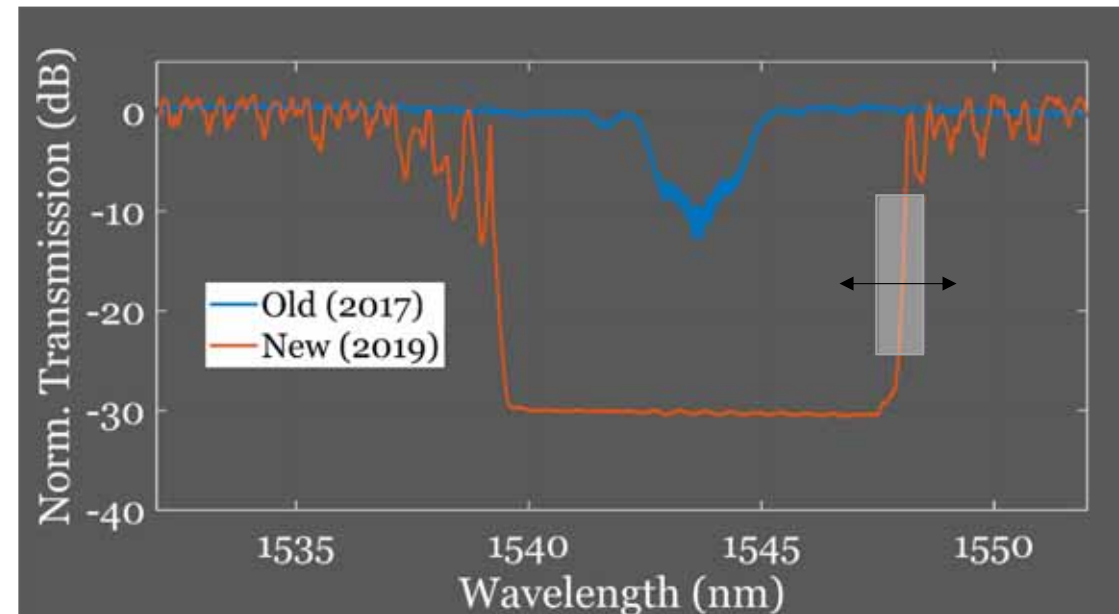
Concept of the Bragg Modulator

Distributed Bragg reflector

Multilayers of alternating materials with varying n , each layer causes a partial reflection



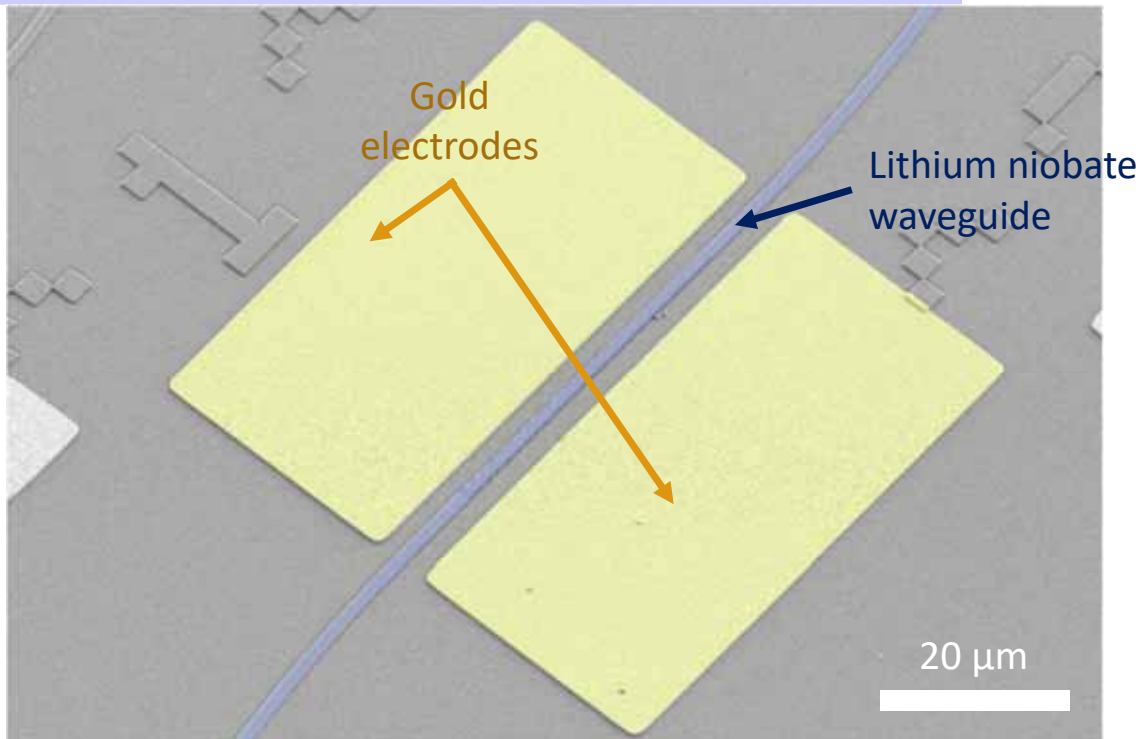
Stop band in transmission



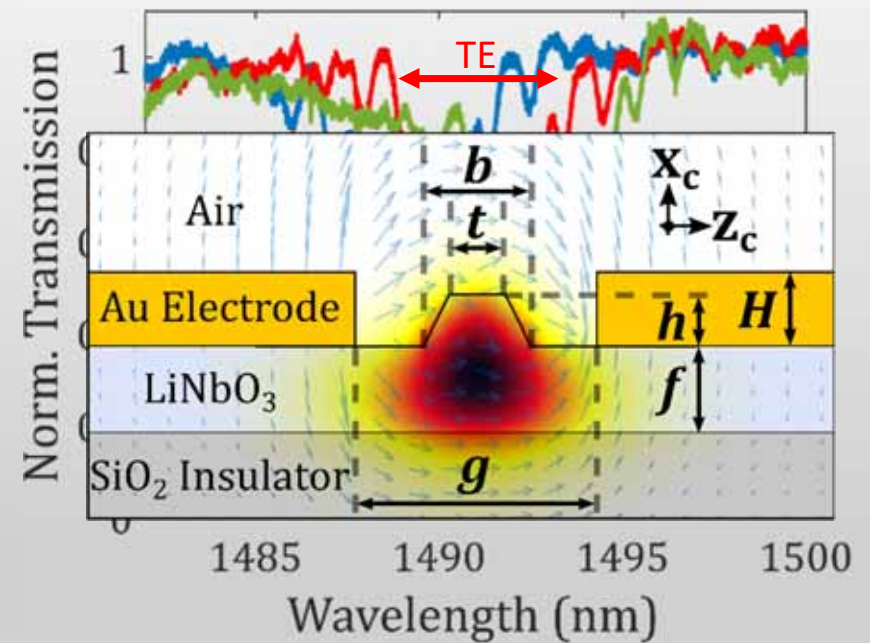
Concept of the Bragg Modulator

Electro-optic modulation

Multilayers of alternating materials with varying n , each layer causes a partial reflection

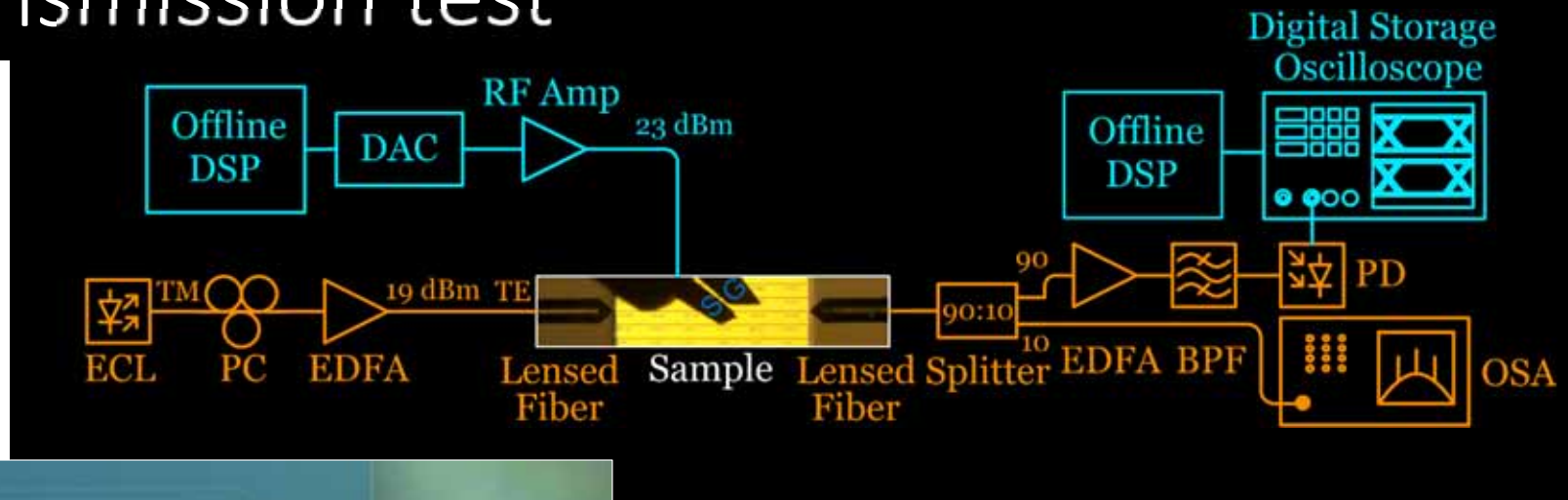


Wavelength tuning of the stop band



M. Reig Escalé et al., Optics Letters 43(7), 1515-1518, 2018

Data transmission test



Collaboration with Juerg Leuthold, ETH, D-ITET

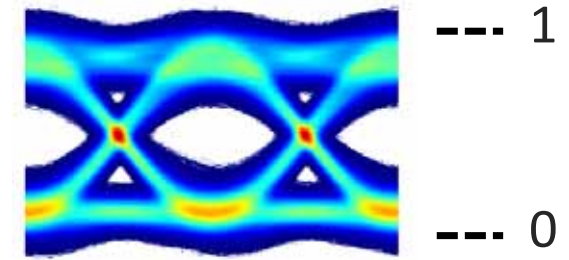
Data transmission test

100 Gbit/s with $10 \times 500 \mu\text{m}^2$ footprint

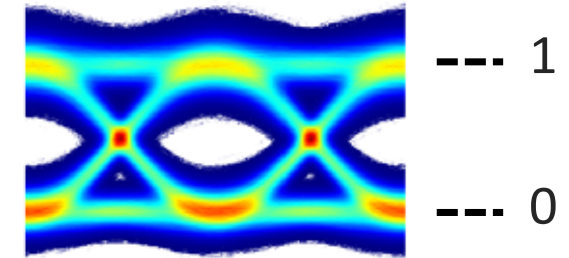


Collaboration with Juerg Leuthold, ETH, D-ITET

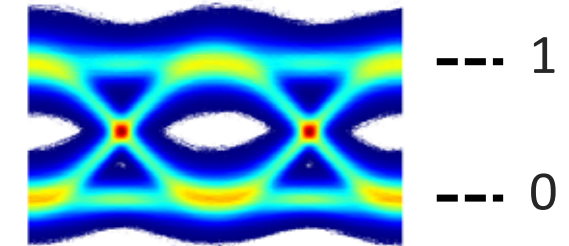
25 Gbit/s
BER $< \sim 10^{-6}$



50 Gbit/s
BER = $1.9 \cdot 10^{-6}$



100 Gbit/s
BER = 1.3×10^{-5}



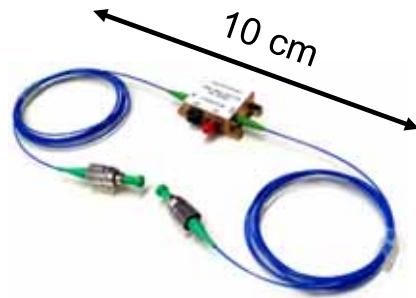
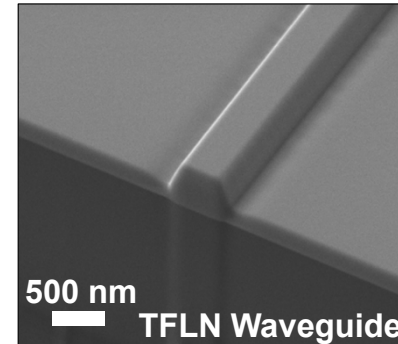
$V_{pp} = 8.9 \text{ V at } 50 \Omega$ $<$ Hard Decision threshold

Vertically Integrated Device Manufacturer



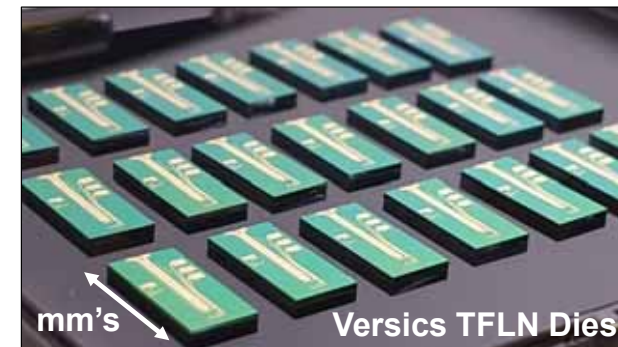
Design
Simulation, Process
Design Kit (PDK)

Microfabrication
Test Design Kit (TDK),
Process Control

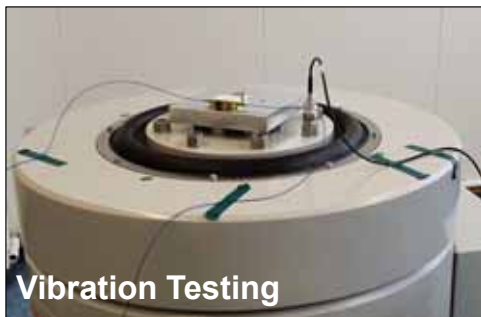


Assembly
Assembly Design
Kit (ADK)

Reliability
Telcordia GR-468-CORE



Versics Reliability Labs

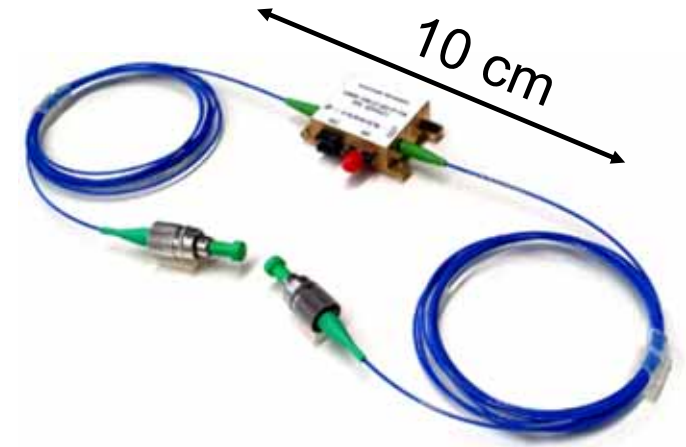


Sales

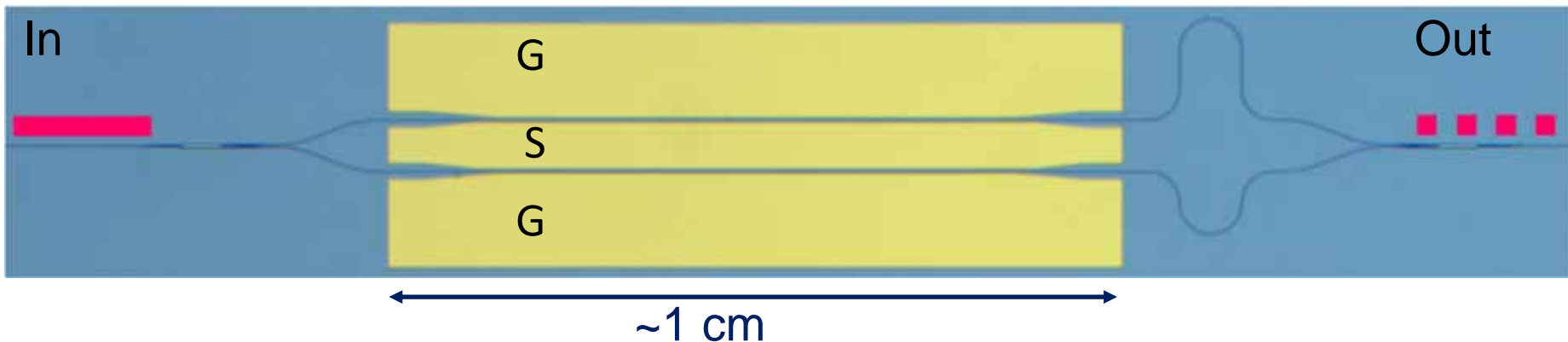
IAS ACCREDITED
Management Systems
Certification Body
ISO 9001:2015
ISO 14001:2015

Example: Versics Amplitude Modulator (VAM)

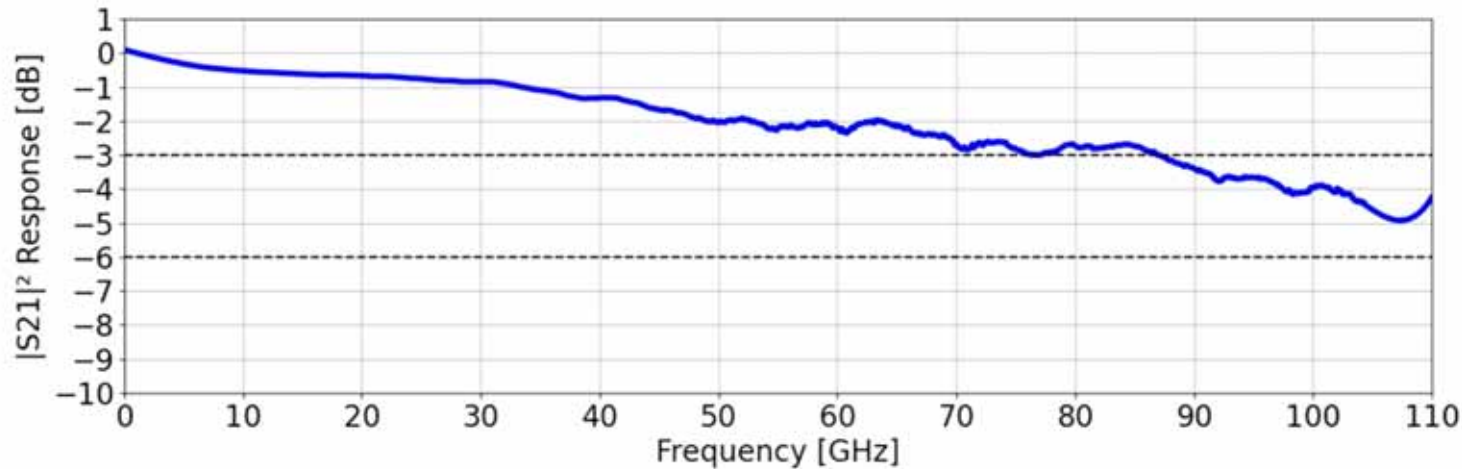
- Assembled modulator
- Ideal for Test & Measurement applications



Mach-Zehnder configuration (example)



Example: Versics Amplitude Modulator (VAM)



**85 GHz with 1.8V in
O-band and 2.1V in C-
band**

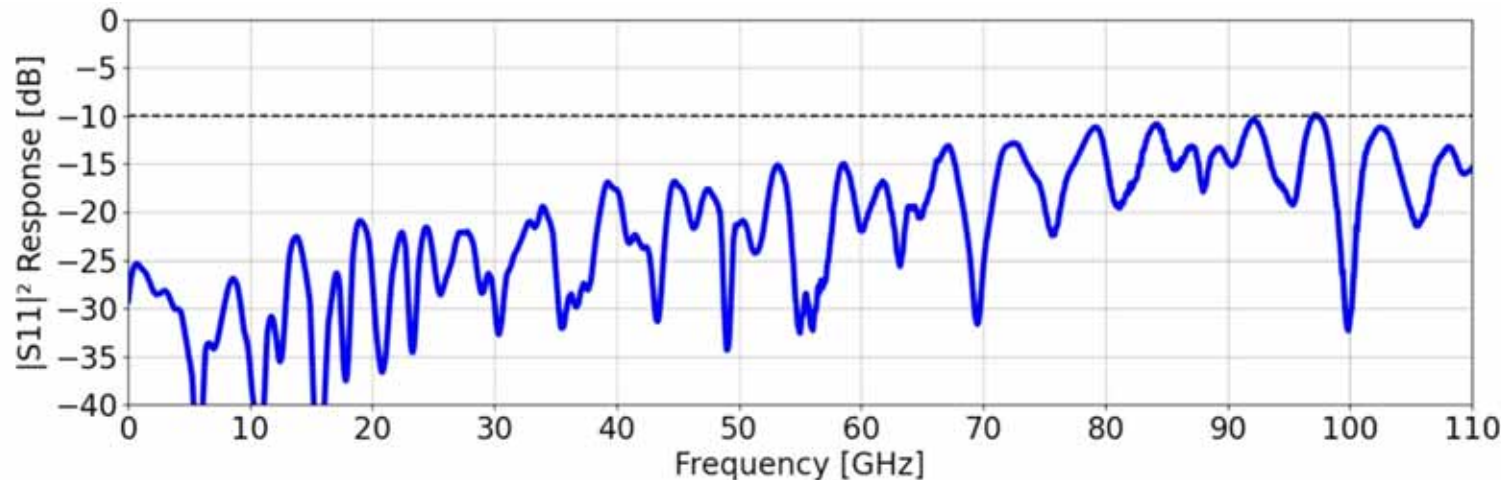
Electrical

Electro-optic bandwidth	S_{21}	>85 GHz
Electrical reflection coefficient	S_{11}	<10 dB
$V_{\pi\text{-RF}}$ @ 200 kHz (O / C-band)	$V_{\pi\text{-RF}200\text{kHz}}$	1.8 V / 2.1 V
RF input impedance	$Z_{\text{in-RF}}$	50 Ω
RF connector	W-type	1.00 mm

marc.reig@versics.com

VERSICS...
HIGH-SPEED PHOTONIC SOLUTIONS

Example: Versics Amplitude Modulator (VAM)



- for the data center and telecom market, **Versics AG** is currently developing the **1.6T** and **3.2T** PICs

- only PICs to be integrated within transceivers by customers

Optical

Crystal	-	LNOI, X-cut, Y-prop
Insertion loss (O / C-band)	IL	<7 dB
DC extinction ratio	ER	>25 dB
Optical return loss	ORL	>20 dB

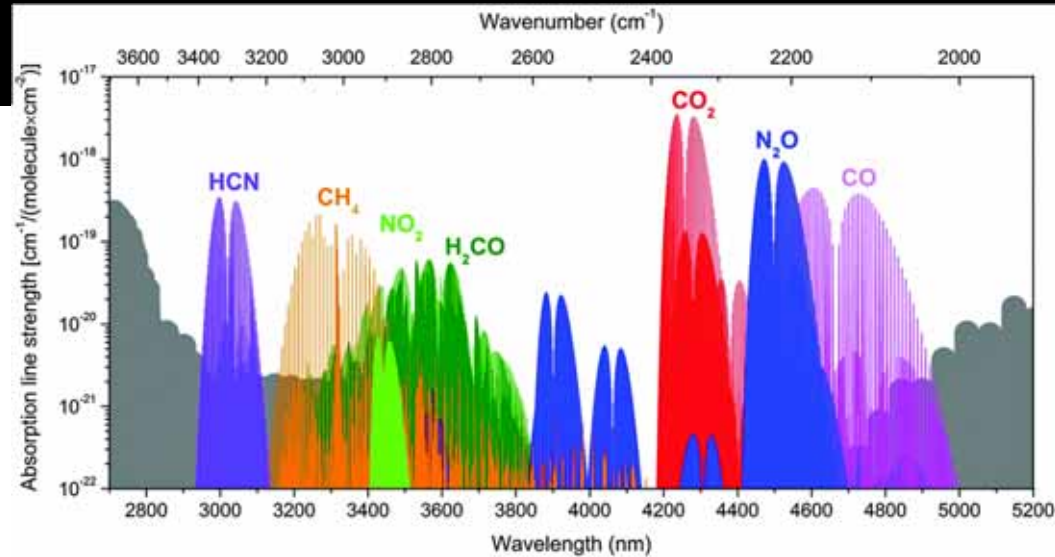
All specifications are given at 25°C, unless differently specified.

marc.reig@versics.com

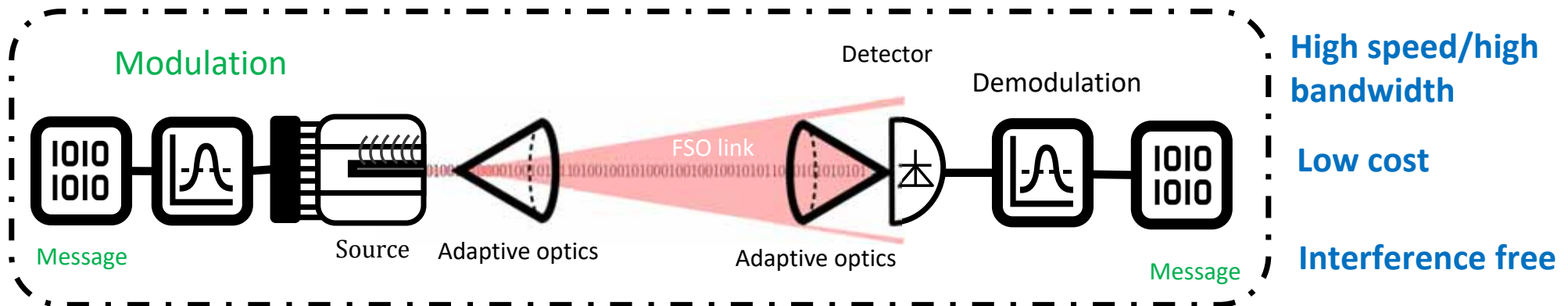
VERSICS...
HIGH-SPEED PHOTONIC SOLUTIONS

Why LiNbO₃ on Sapphire?

Strong absorption of important environmental molecules



High-speed Free Space Optics (FSO)

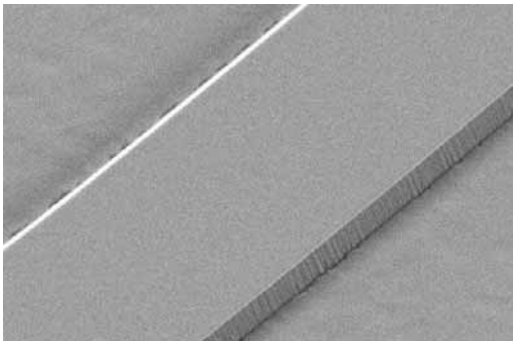


[1] Vainio, M., & Halonen, L. (2016). Physical Chemistry Chemical Physics, 18(6), 4266-4294.

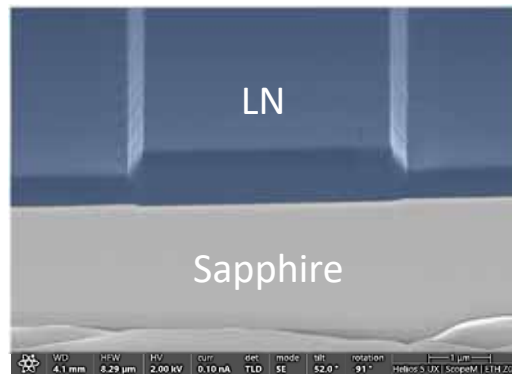
[2] Schliesser, A., Picqué, N., & Hänsch, T. W. (2012). Nature photonics, 6(7), 440-449.

Fabrication of LNOS for mid-infrared applications

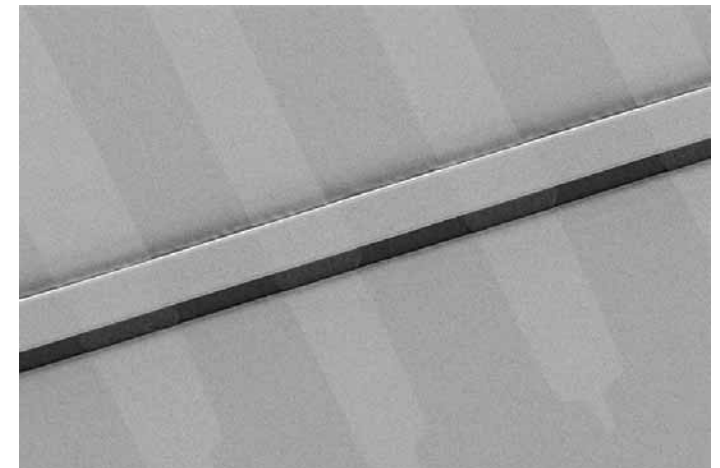
Waveguide



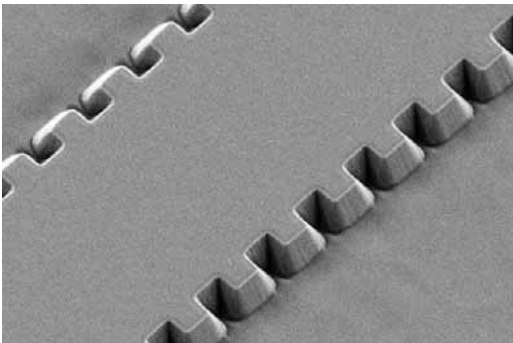
Facet



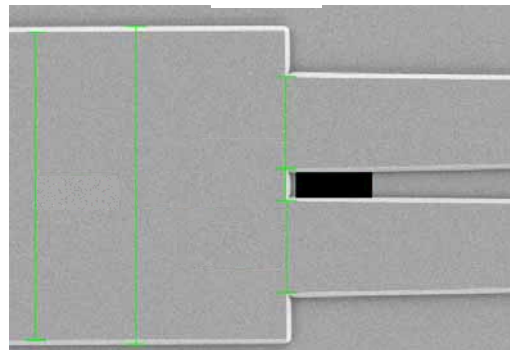
Periodically poled lithium niobate on sapphire



Bragg reflector (for 3.7 and 4 μm)

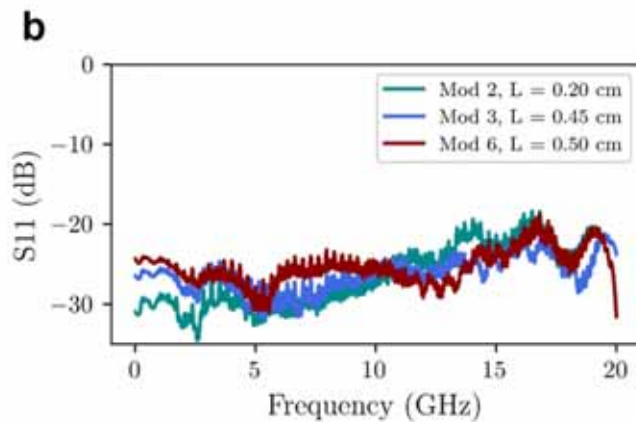
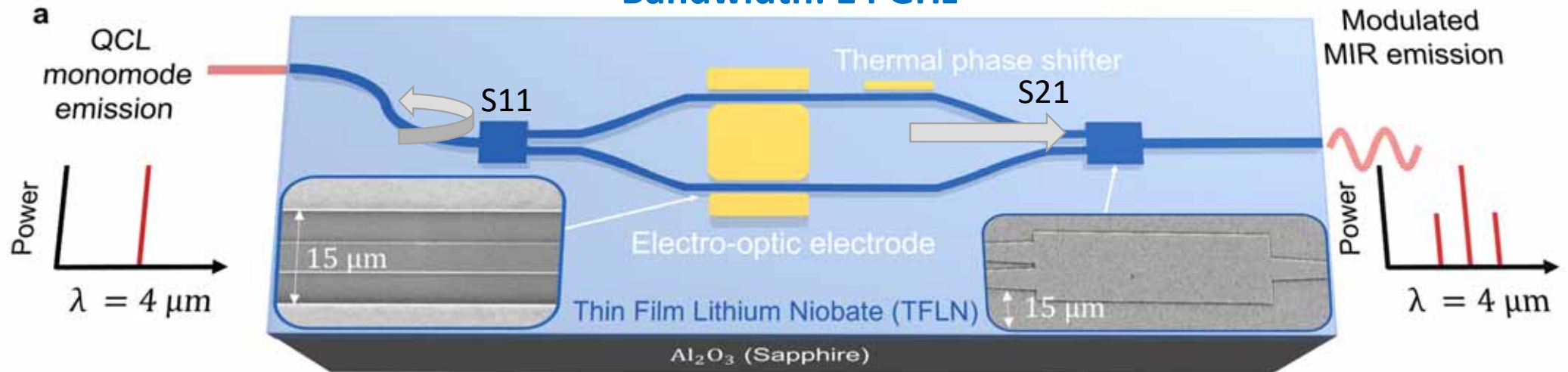


MMI



Mid-Infrared modulators in LiNbO₃ on Sapphire

Bandwidth: 14 GHz

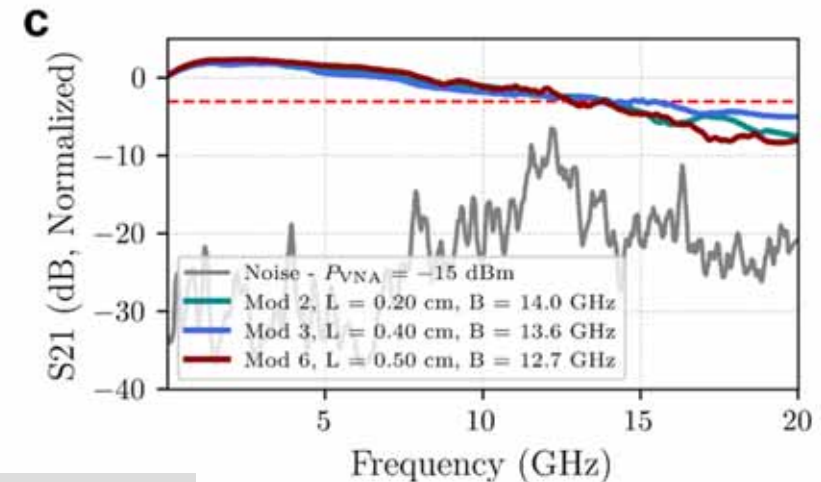


$$V_{\pi} = 31 \text{ V}\cdot\text{cm}$$

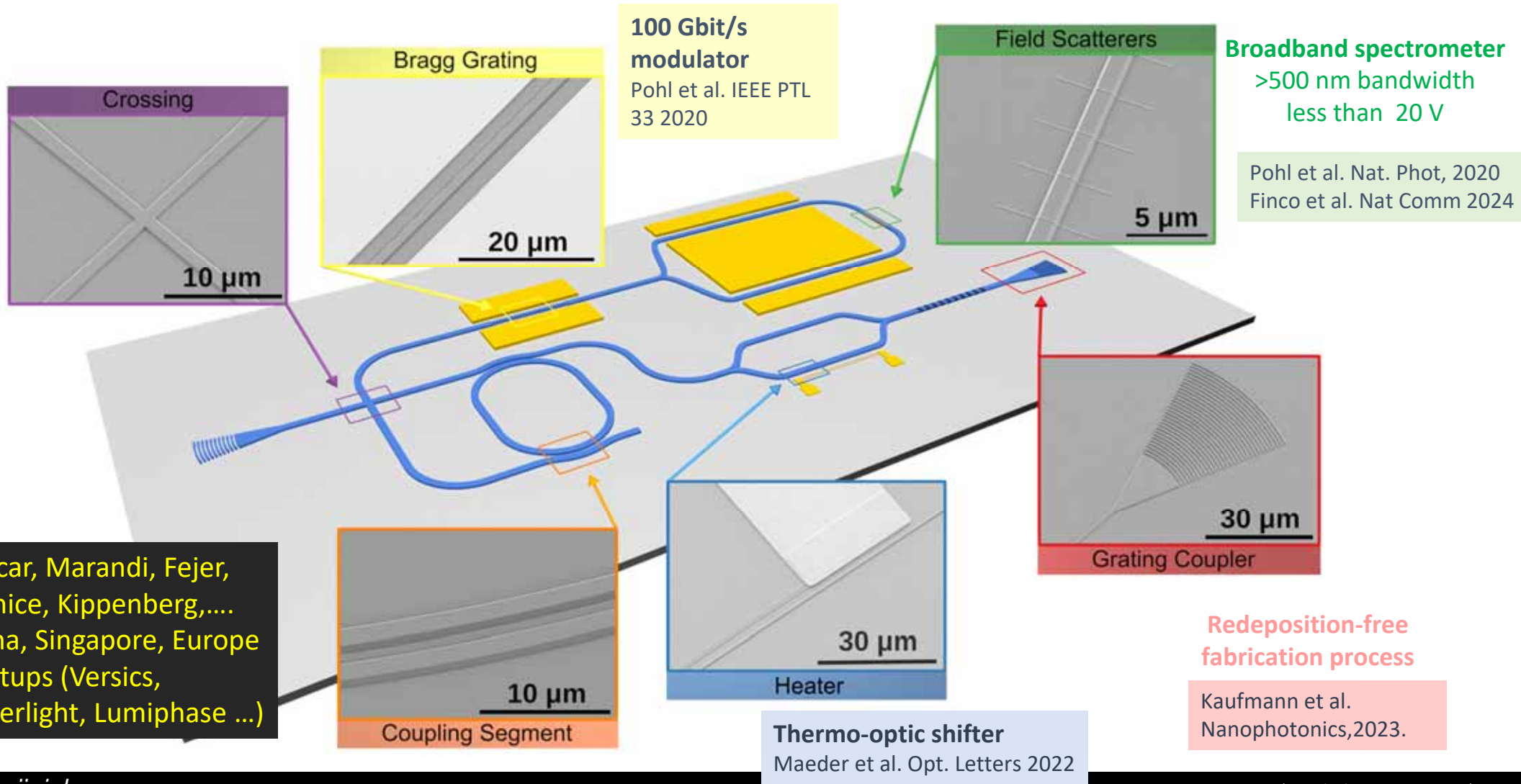
Prop. Losses 1.9 dB/cm

Device lengths 0.25 to 0.5 cm

Electrode gaps 4.5 and 5 μm .

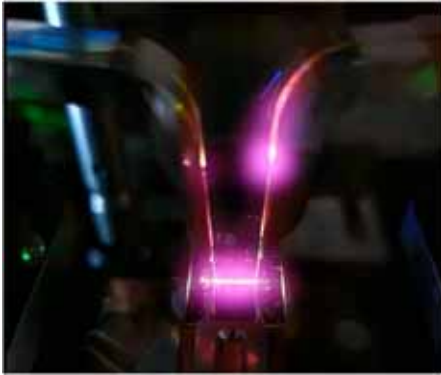


Lithium niobate on insulator for photonic integrated circuit (PIC)



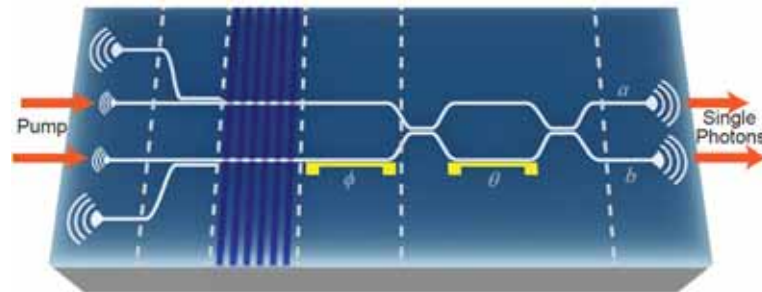
Perspective 1: SPDC for photonic integrated circuits

Periodically Poled LNOI

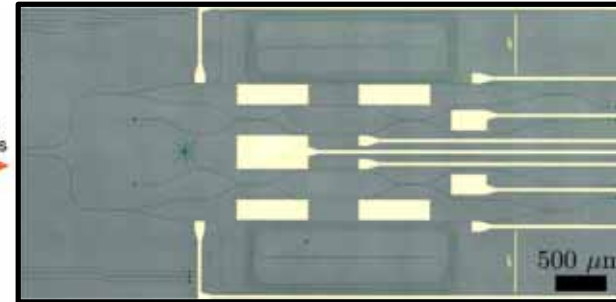


Sabatti, Kellner et al, **OPTICA**, 12, 5, 2025

On chip source for inverse HOM/ QKD

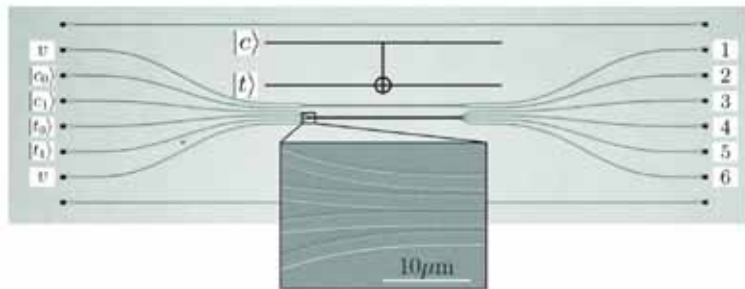


Chapman R. et al. PRL 2025
Maeder et al. 2024



Finco et al. npj Quantum
Information 2025

Two-qubit controlled-NOT gate

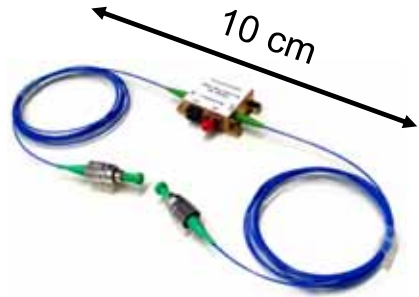


Chapman R. et al. Quantum Sci. Technol. 9 2024

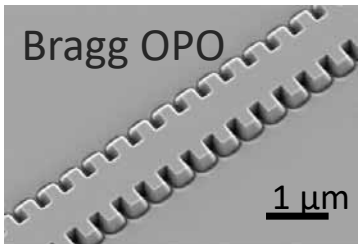
LNOI for quantum

Zhao et al. Physical Review Letters 124, (2020)
Nehra, et al. Science 377, 1333–1337 (2022)
Sund, et al. Science Advances 9, eadg7268 (2023)
Warner et al. Nature Physics 21, 831–838 (2025).

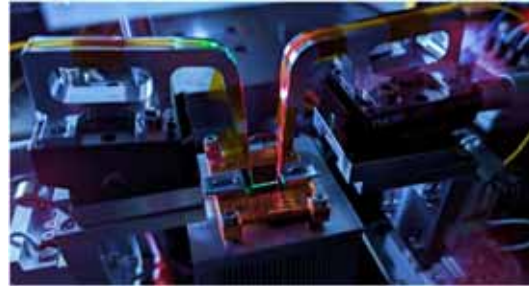
$\chi^{(2)}$ materials for top-down & bottom-up for PICs



VERSICS
HIGH-SPEED PHOTONIC SOLUTIONS
marc.reig@versics.com

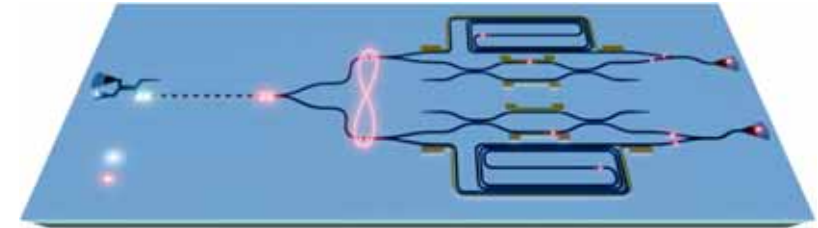


Sabatti, Kellner et al.
Optica 2025

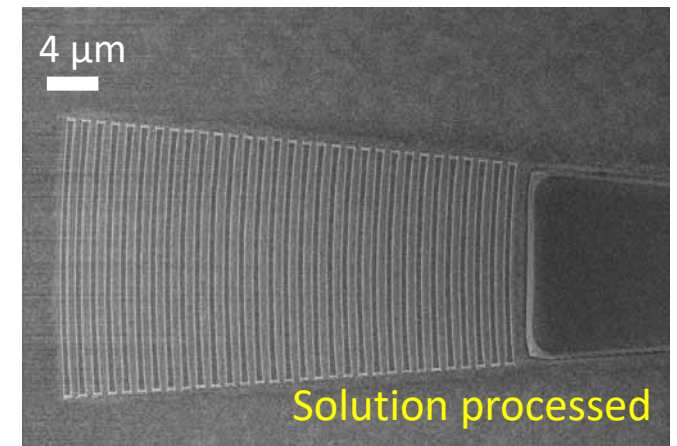


ong.ethz.ch
grange@phys.ethz.ch

Entangled qubit generation by SPDC



Finco et al. npj Quantum Information 2024
Maeder, Quantum Sci. Technol. 9 2024
Chapman et al. PRL 2025



Talts et al. Adv. Materials 2025
Weigand et al, Nano Lett 24